Technical Data Sheet

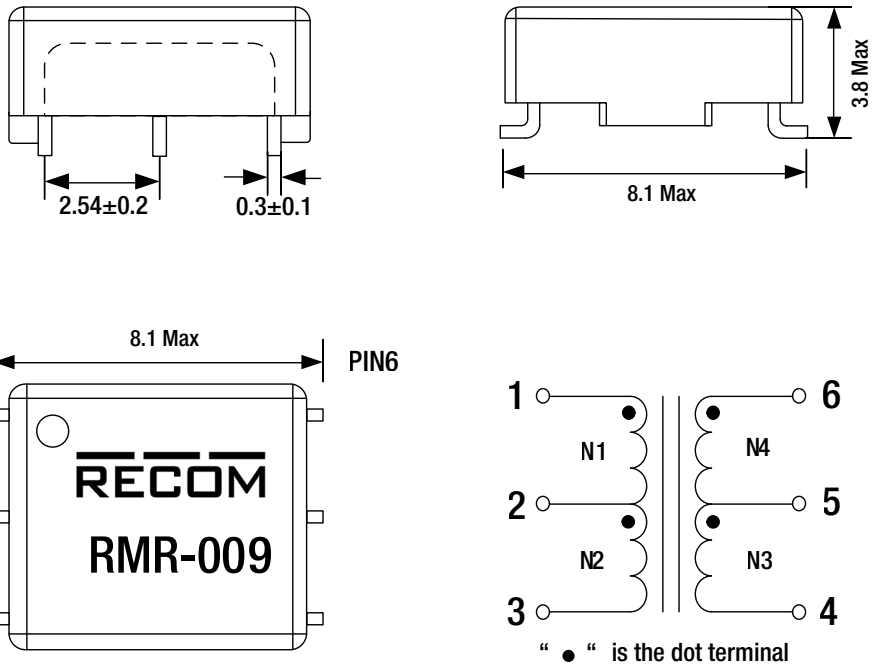
RMR-009 ◊ Flyback Transformer

1W ◊ SMD ◊ 1.5kVDC Isolation

FEATURES

- Small-sized isolation transformer
- SMD surface mount installation
- Isolation voltage: 1500VDC/1minute
- Operating temperature: -40~125°C
- Maximum product dimensions: 8.1mm × 6.8mm × 3.8mm

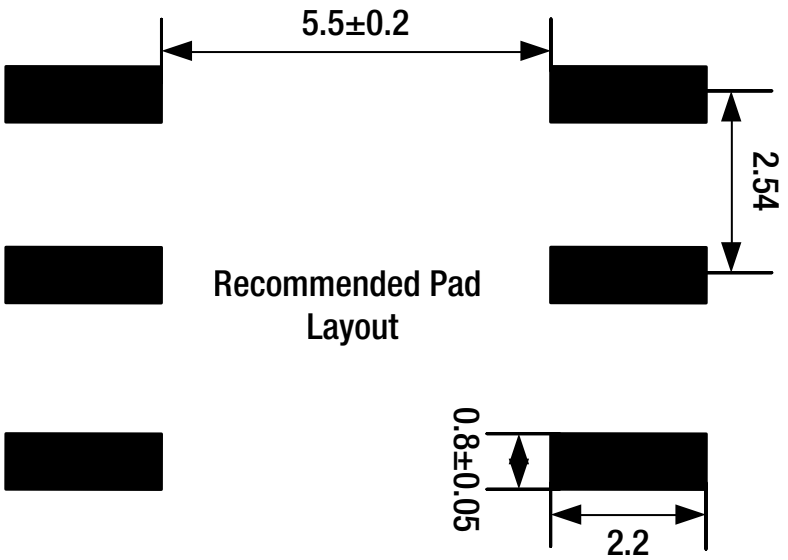
DIMENSIONS AND SCHEMATIC DIAGRAM [mm]



PRODUCT MARKING

Pin1	○
Marking	Company Logo
	Product Model

RECOMMENDED LAND PATTERN [mm]



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BASIC CHARACTERISTIC (measured @ TAMB= 25°C, nominal Input and full load after warm-up time unless otherwise stated)

Properties		Test Conditions	Value	Unit
Inductance	L	N1/100kHz/0.1V	121 min.	µH
Turns Ratio	n	N1:N2:N3:N4	1.31:1.31:1:1	
DC Resistance 1	R_{DC1}	N1:N2/25°C	0.25 max.	Ω
DC Resistance 2	R_{DC2}	N3:N4 /25°C	0.22 max.	Ω
Voltage-µSecond	$\int_{Udt}$	N1/ bipolar waveform	10.3	Vµs
Interwinding Capacitance	C_{WW}	PIN1-6/100kHz/ 0.1V/25°C	20 max.	pF
Leakage Inductance	L_S	N1/100kHz/0.1V, all other terminals short	0.5 max.	µH
Isolation Test Voltage	V_T	N1,2: N3,4/60s/1mA	1500	VDC

GENERAL INFORMATION

Operating Temperature (including temperature rise)	-40~125°C
Storage Temperature	-40~125°C
Storage Conditions (in original packaging)	<40°C/<75%RH
Moisture Sensitivity Level (MSL)	1
Insulation Grade	Functional

MATERIAL CERTIFICATION

ITEM		UL NO
1	Case	E150608
2	Wire	E253843
3	Varnish	E314793

ENVIRONMENTAL COMPLIANCE

RoHS Approval	Compliant [2011/65/EU&2015/863]
REACH Approval	Conform or declared [(EC)1907/2006]
Halogen Free	Conform [EN 14582:2016]

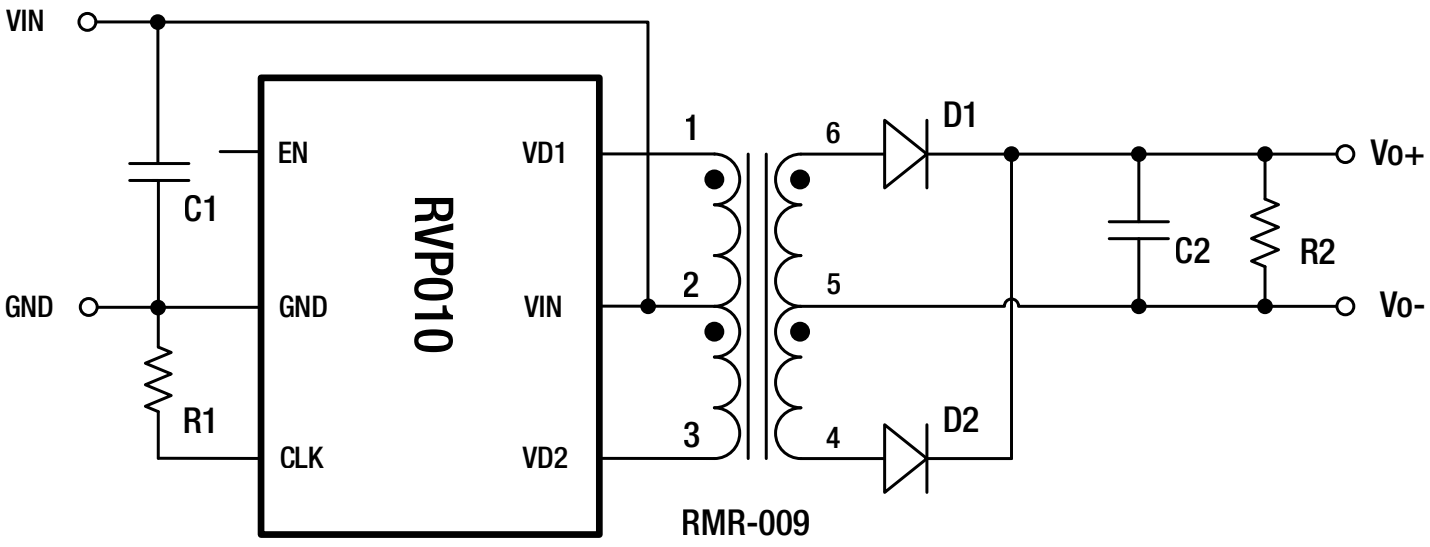
TYPICAL APPLICATION

Parameter		Value	Unit
Input Voltage	V_{IN}	5	VDC
Output Voltage 1	V_{OUT1}	3.3	VDC
Output Current 1	I_{OUT1}	303	mA
Switching Frequency	f_{switch}	390	kHz

Input: N1/N2
Output 1: N3/N4

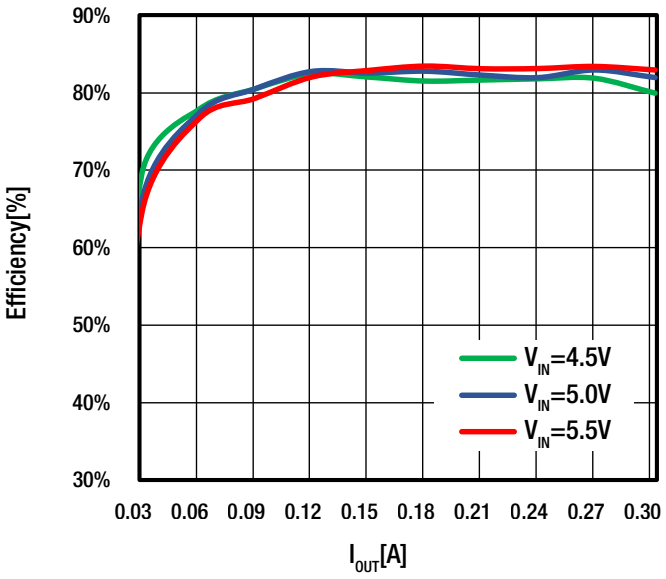
Table and graph show a typical application. Values may vary by application.

REFERENCE CIRCUIT DIAGRAM

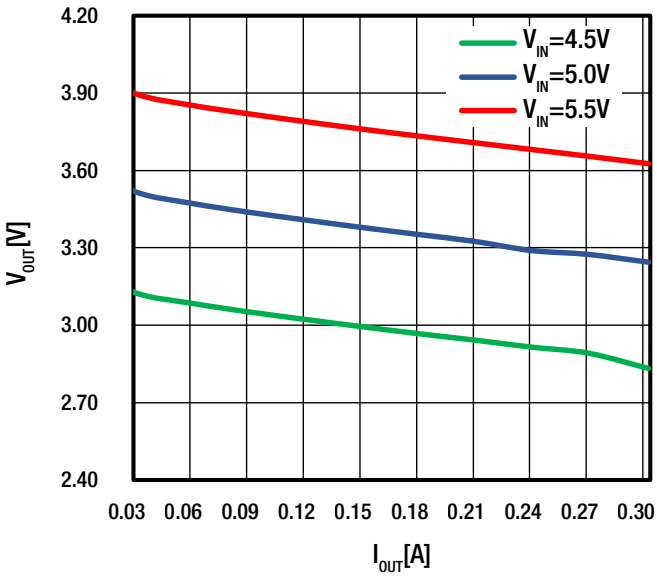


Typical Curve:

Typical Efficiency vs. Output Current



Typical Output Voltage vs. Output Current



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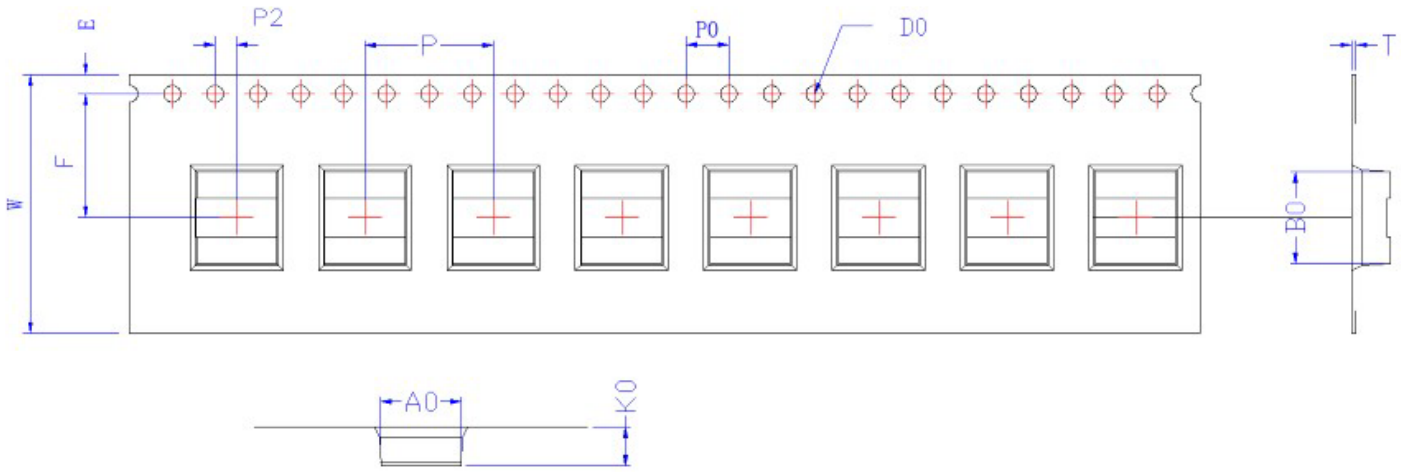
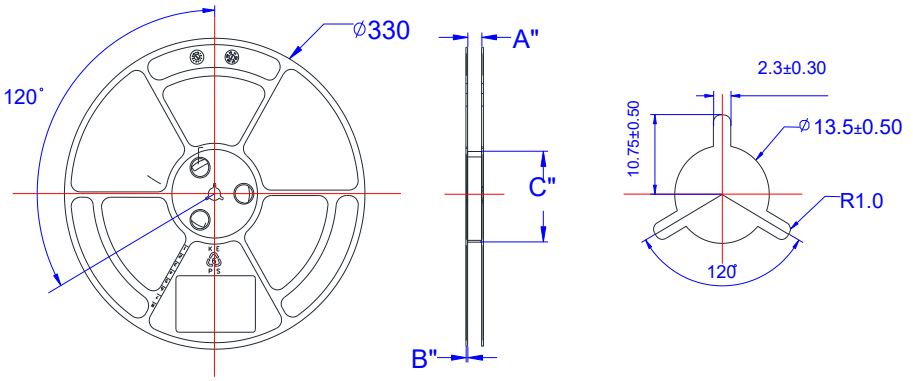
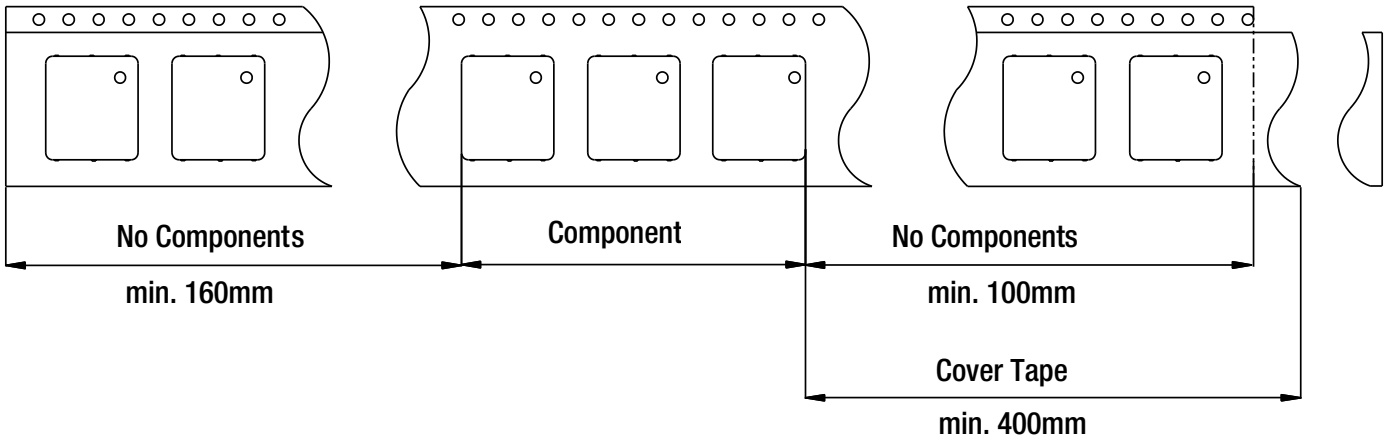
PACKAGING SPECIFICATION - TAPE & REEL [mm]													
ITRM	W	A0	B0	K0	K1	P	F	E	D0	D1	P0	P2	T
DIM	24.00	7.10	8.20	3.75	--	12.00	11.50	1.75	1.50	--	4.00	2.00	0.40
TOLE	+0.30 -0.30	+0.15 -0.15	+0.15 -0.15	+0.10 -0.10	+0.10 -0.10	+0.10 -0.10	+0.10 -0.10	+0.10 -0.10	+0.10 -0.10	+0.10 -0.00	+0.10 -0.10	+0.15 -0.15	+0.05 -0.05

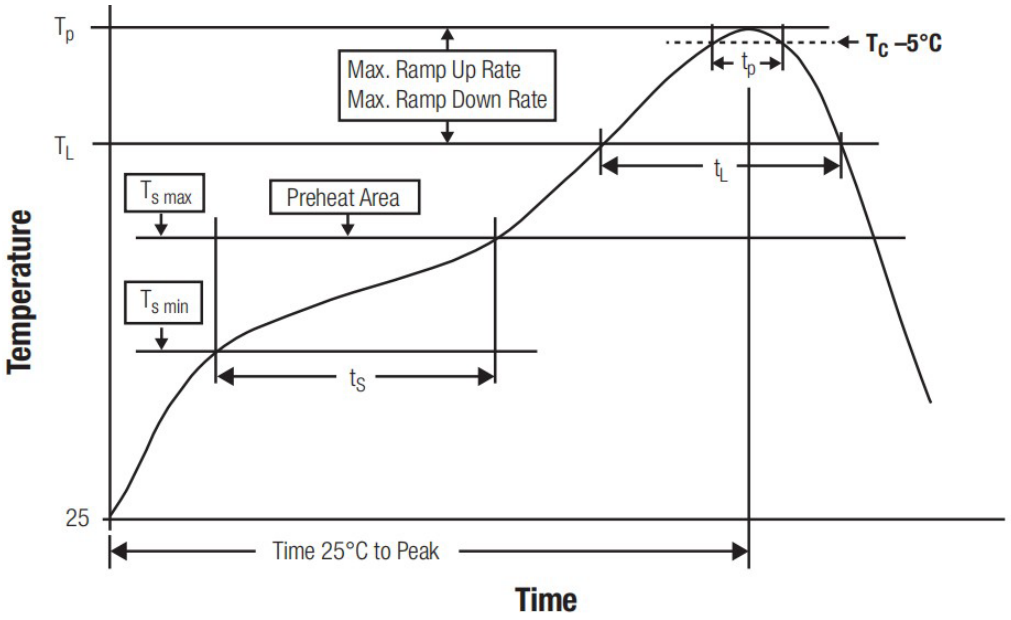




		✓			
SPEC	16	24	32	44	56
DIM A" ± 0.5	16.5	24.5	32.5	44.5	56.5
DIM B" ± 0.3	2.10	2.10	2.10	2.10	2.10
DIM C" ± 0.5	100	100	100	100	100



REFLOW SOLDERING



Profile Feature		Value
Preheat Temperature Min	$T_{s\,min}$	150°C
Preheat Temperature Max	$T_{s\,max}$	200°C
Preheat Time t_s from $T_{s\,min}$ to $T_{s\,max}$	t_s	100 seconds
Ramp-up Rate (T_L to T_P)		3°C/second max.
Liquidous Temperature	T_L	217°C
Time t_L maintained above T_L	t_L	100 seconds
Peak package body temperature	T_P	$T_P \leq T_C$, see Table below
Time within 5°C of actual peak temperature	t_P	30 seconds
Ramp-down Rate (T_P to T_L)		6°C/second max.
Time 25°C to peak temperature		5 minutes max.
Reflow soldering temperature		Peak Temperature ≤250°C (10s)
Reflow Soldering Cycles		Recommended ≤ 2 Cycles

Refer to IPC/JEDEC J-STD-020F

PACKAGE CLASSIFICATION REFLOW TEMPERATURE (T_C)

Properties	Volume mm^3 <350	Volume mm^3 350-2000	Volume mm^3 >2000
PB-Free Assembly | Package Thickness < 1.6 mm	260°C	260°C	260°C
PB-Free Assembly | Package Thickness 1.6 mm - 2.5 mm	260°C	250°C	245°C
PB-Free Assembly | Package Thickness > 2.5 mm	250°C	245°C	245°C

Refer to IPC/JEDEC J-STD-020F

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ORDER INFORMATION

Order Code	Marking Code*	Weight (g/pcs)	Package Type	Quantity (pcs/Reel)
RMR-009-AD5S-R	RMR-009	0.2g	Tape & Reel	1500pcs

*Marking Code

RMR-009—— Product Code